

# Switching diode

## 1SS400

### ● Applications

High speed switching

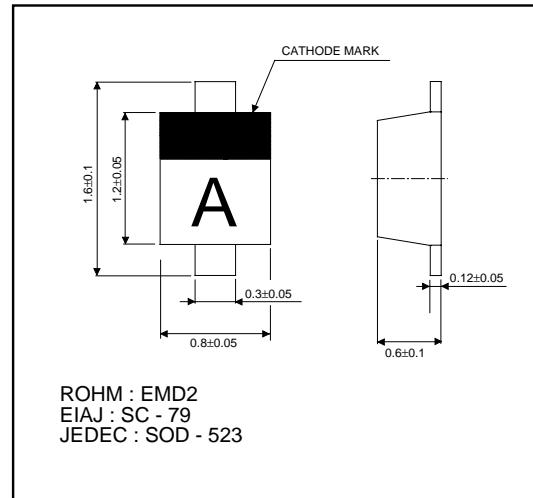
### ● Features

- 1) Extremely small surface mounting type.(EMD2)
- 2) High Speed.( $t_r=1.2\text{ns}$  Typ.)
- 3) High reliability.

### ● Construction

Silicon epitaxial planar

### ● External dimensions (Units : mm)



### ● Absolute maximum ratings ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Limits	Unit
Peak reverse voltage	$V_{RM}$	90	V
DC reverse voltage	$V_R$	80	V
Peak forward current	$I_{FM}$	225	mA
Mean rectifying current	$I_o$	100	mA
Surge current (1s)	$I_{surge}$	500	mA
Junction temperature	$T_j$	125	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 ~ +125	$^\circ\text{C}$

### ● Electrical characteristics ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	$V_F$	-	-	1.2	V	$I_F=100\text{mA}$
Reverse current	$I_R$	-	-	0.1	$\mu\text{A}$	$V_R=80\text{V}$
Capacitance between terminals	$C_T$	-	0.72	3.0	pF	$V_R=0.5\text{V}$ , $f=1\text{MHz}$
Reverse recovery time	$t_{rr}$	-	-	4	ns	$V_R=6\text{V}$ , $I_F=10\text{mA}$ , $R_L=100\Omega$

## Diodes

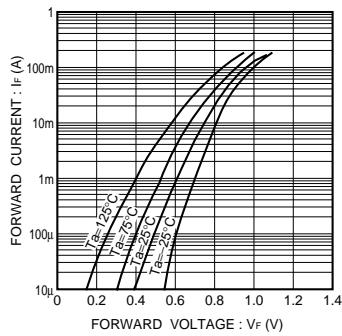
● Electrical characteristic curves ( $T_a = 25^\circ\text{C}$ )

Fig.1 Forward characteristics

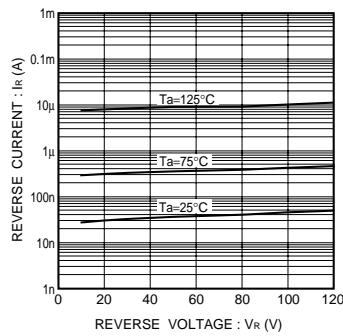


Fig.2 Reverse characteristics

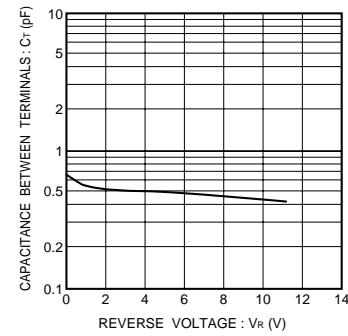


Fig.3 Capacitance between terminals

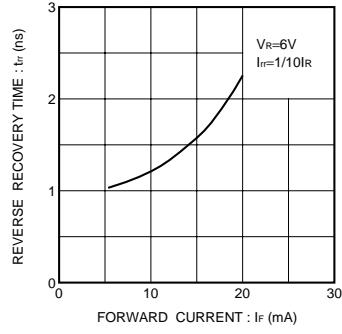


Fig.4 Reverse recovery time characteristics

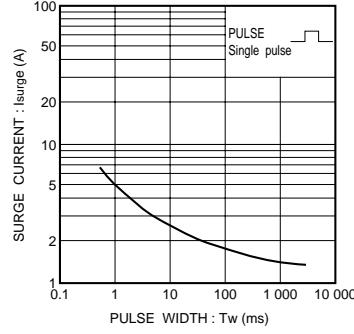
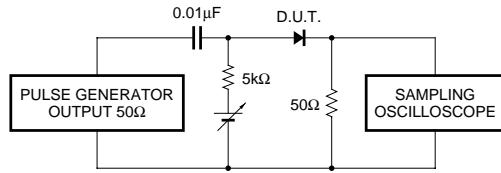


Fig.5 Surge current characteristics

Fig.6 Reverse recovery time (t<sub>rr</sub>) measurement circuit**ROHM**